## **Surface Mount Schottky Power Rectifier SMA Power Surface Mount Package**

Employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity diodes in surface mount applications where compact size and weight are critical to the system.

## Features

- Small Compact Surface Mountable Package with J-Bent Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Guardring for Stress Protection
- NRVBA Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb–Free Devices

## **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm tape, 5000 units per 13 inch reel
- Polarity: Cathode Lead Indicated by Polarity Band
- ESD Ratings: Machine Model = C Human Body Model = 3B
- Device Meets MSL 1 Requirements

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
Average Rectified Forward Current (At Rated $V_R$ , $T_L$ = 100°C)	Ι <sub>Ο</sub>	3.0	A
Non–Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	80	A
Storage Temperature	T <sub>stg</sub>	-65 to +150	°C
Operating Junction Temperature	TJ	-65 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/µs

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



## **ON Semiconductor®**

http://onsemi.com

## SCHOTTKY BARRIER RECTIFIER 3.0 AMPERES **20 VOLTS**







## MARKING DIAGRAM





А Υ

WW = Work Week

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRA320T3G	SMA (Pb–Free)	5000/Tape & Reel
NRVBA320T3G	SMA (Pb–Free)	5000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

<sup>=</sup> Pb-Free Package

## THERMAL CHARACTERISTICS

15 80	°C/W
	15 80

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2)	$(I_F = 3.0 \text{ A}, \text{ T}_J = 25^{\circ}\text{C})$	V <sub>F</sub>	0.50		Volts
Maximum Instantaneous Reverse Current (Note 2)	<i>() (</i>	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
	(V <sub>R</sub> = 20 V)		2.0	20	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Mounted on 2" Square PC Board with 1" Square Total Pad Size, PC Board FR4.
Pulse Test: Pulse Width = 300 s, Duty Cycle ≤ 2.0%.



## **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**



Figure 8. Thermal Response, Junction-to-Ambient (min pad)



Figure 9. Thermal Response, Junction to Ambient (1 inch pad)

#### PACKAGE DIMENSIONS

SMA CASE 403D-02 ISSUE G



NOTES 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.



	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.97	2.10	2.20	0.078	0.083	0.087
A1	0.05	0.10	0.20	0.002	0.004	0.008
b	1.27	1.45	1.63	0.050	0.057	0.064
С	0.15	0.28	0.41	0.006	0.011	0.016
D	2.29	2.60	2.92	0.090	0.103	0.115
E	4.06	4.32	4.57	0.160	0.170	0.180
HE	4.83	5.21	5.59	0.190	0.205	0.220
L	0.76	1.14	1.52	0.030	0.045	0.060





#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**MBRA320/D**